



SLP32N20C / SLF32N20C

200V N-Channel MOSFET

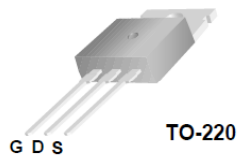
SLP32N20C / SLF32N20C

General Description

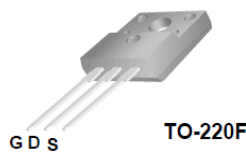
This Power MOSFET is produced using True semi's advanced planar stripe DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switched mode power supplies, active power factor correction based on half bridge topology.

Features

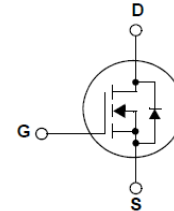
- 32A, 200V, $R_{DS(on) typ.} = 0.080\Omega @ V_{GS} = 10V$
- Low gate charge (typical 50 nC)
- High ruggedness
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability



TO-220



TO-220F



Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter	SLP32N20C	SLF32N20C	Units
V _{DSS}	Drain-Source Voltage	200		V
I _D	Drain Current - Continuous (T _C = 25°C)	32	32 *	A
		19.2	19.2 *	A
I _{DM}	Drain Current - Pulsed (Note 1)	128	128 *	A
V _{GSS}	Gate-Source Voltage	±30		V
E _{AS}	Single Pulsed Avalanche Energy (Note 2)	1120		mJ
I _{AR}	Avalanche Current (Note 1)	32		A
E _{AR}	Repetitive Avalanche Energy (Note 1)	25.6		mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)	4.5		V/ns
P _D	Power Dissipation (T _C = 25°C) - Derate above 25°C	256	41.8	W
		2.05	0.34	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range	-55 to +150		°C
T _L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	300		°C

* Drain current limited by maximum junction temperature.

Thermal Characteristics

Symbol	Parameter	SLP32N20C	SLF32N20C	Units
R _{θJC}	Thermal Resistance, Junction-to-Case	0.49	3.0	°C/W
R _{θJS}	Thermal Resistance, Case-to-Sink Typ.	0.5	--	°C/W
R _{θJA}	Thermal Resistance, Junction-to-Ambient	62.5	62.5	°C/W

Electrical CharacteristicsT_C = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
Off Characteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA	200	--	--	V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	I _D = 250 μA, Referenced to 25°C	--	0.2	--	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 200 V, V _{GS} = 0 V	--	--	1	μA
		V _{DS} = 160 V, T _C = 125°C	--	--	10	μA
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V	--	--	100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -30 V, V _{DS} = 0 V	--	--	-100	nA
On Characteristics						
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = 250 μA	2.0	--	4.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 16 A	--	0.080	0.1	Ω
g _{FS}	Forward Transconductance	V _{DS} = 40 V, I _D = 16 A (Note 4)	--	22	--	S
Dynamic Characteristics						
C _{iss}	Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V, f = 1.0 MHz	--	1560	--	pF
C _{oss}	Output Capacitance		--	370	--	pF
C _{rss}	Reverse Transfer Capacitance		--	150	--	pF
Switching Characteristics						
t _{d(on)}	Turn-On Delay Time	V _{DD} = 100 V, I _D = 32 A, R _G = 25 Ω (Note 4, 5)	--	26	--	ns
t _r	Turn-On Rise Time		--	32	--	ns
t _{d(off)}	Turn-Off Delay Time		--	141	--	ns
t _f	Turn-Off Fall Time		--	83	--	ns
Q _g	Total Gate Charge	V _{DS} = 160 V, I _D = 32 A, V _{GS} = 10 V (Note 4, 5)	--	50	--	nC
Q _{gs}	Gate-Source Charge		--	12	--	nC
Q _{gd}	Gate-Drain Charge		--	22	--	nC
Drain-Source Diode Characteristics and Maximum Ratings						
I _S	Maximum Continuous Drain-Source Diode Forward Current		--	--	32	A
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current		--	--	128	A
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 32 A	--	--	1.4	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _S = 32 A,	--	215	--	ns
Q _{rr}	Reverse Recovery Charge	di _F / dt = 100 A/us (Note 4)	--	1.8	--	μC

Notes:

1. Repetitive Rating : Pulse width limited by maximum junction temperature
2. L = 1.45mH, I_{AS} = 32A, V_{DD} = 50V, R_G = 25Ω, Starting T_J = 25°C
3. I_{SD} ≤ 32A, di/dt ≤ 200A/us, V_{DD} ≤ BV_{DSS}, Starting T_J = 25°C
4. Pulse Test : Pulse width ≤ 300us, Duty cycle ≤ 2%
5. Essentially independent of operating temperature

Typical Characteristics

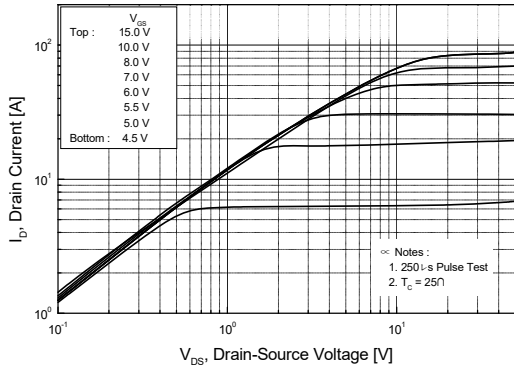


Figure 1. On-Region Characteristics

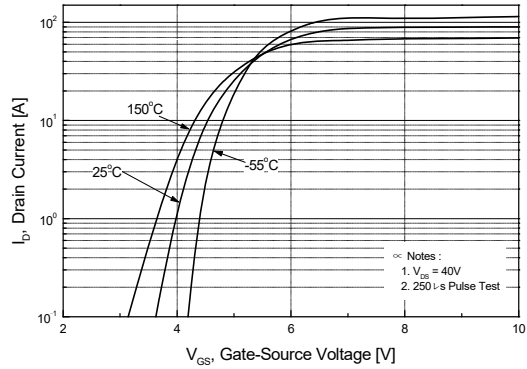


Figure 2. Transfer Characteristics

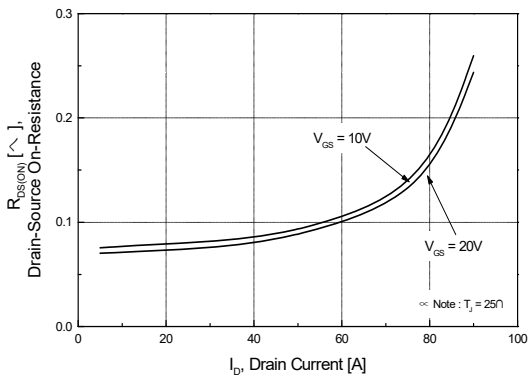


Figure 3. On-Resistance Variation vs Drain Current and Gate Voltage

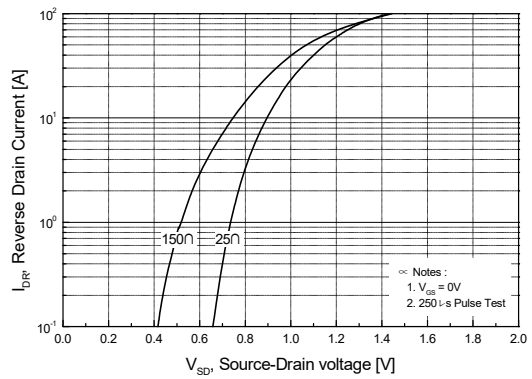


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

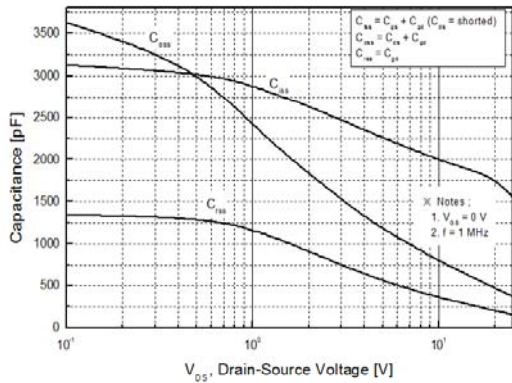


Figure 5. Capacitance Characteristics

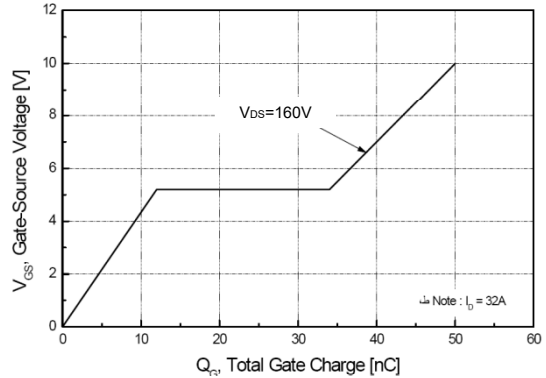


Figure 6. Gate Charge Characteristics

Typical Characteristics (Continued)

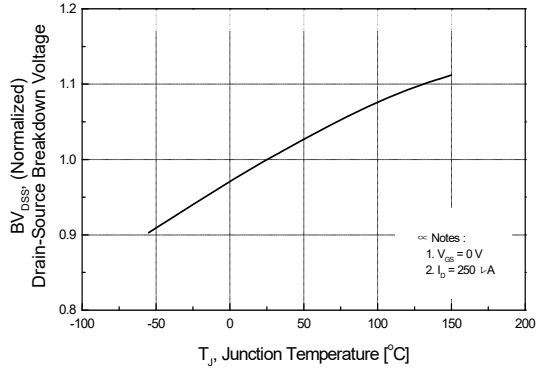


Figure 7. Breakdown Voltage Variation vs Temperature

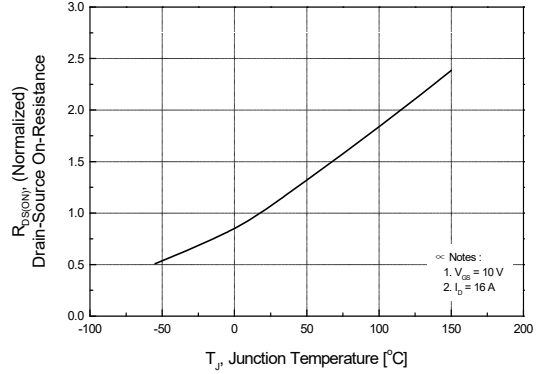


Figure 8. On-Resistance Variation vs Temperature

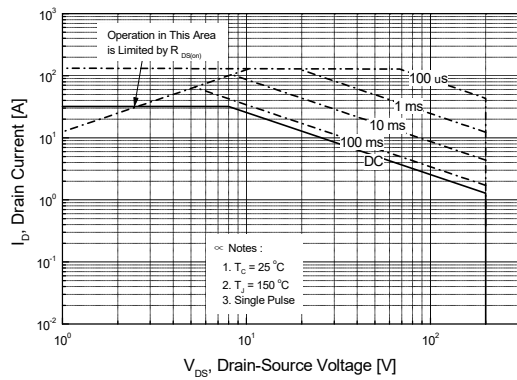


Figure 9-1. Maximum Safe Operating Area for SLP32N20C

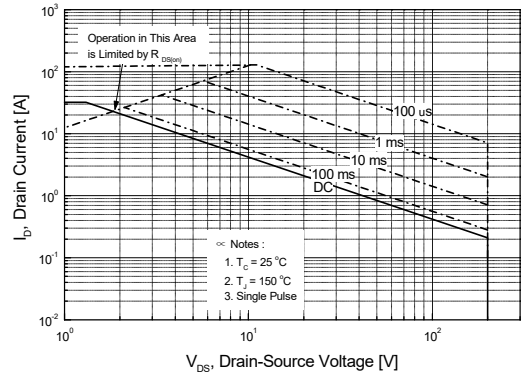


Figure 9-2. Maximum Safe Operating Area for SLF32N20C

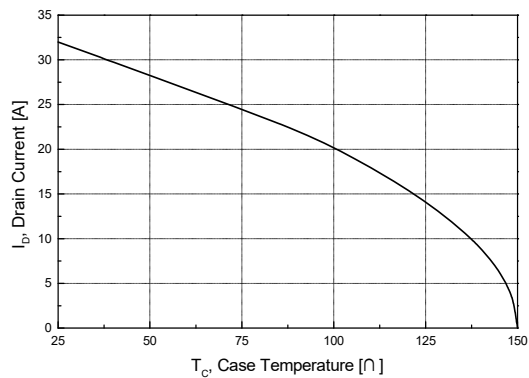


Figure 10. Maximum Drain Current vs Case Temperature

Typical Characteristics

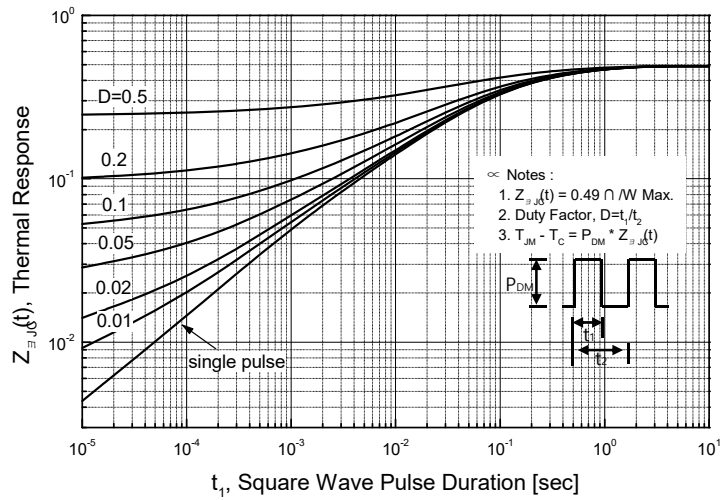


Figure 11-1. Transient Thermal Response Curve for SLP32N20C

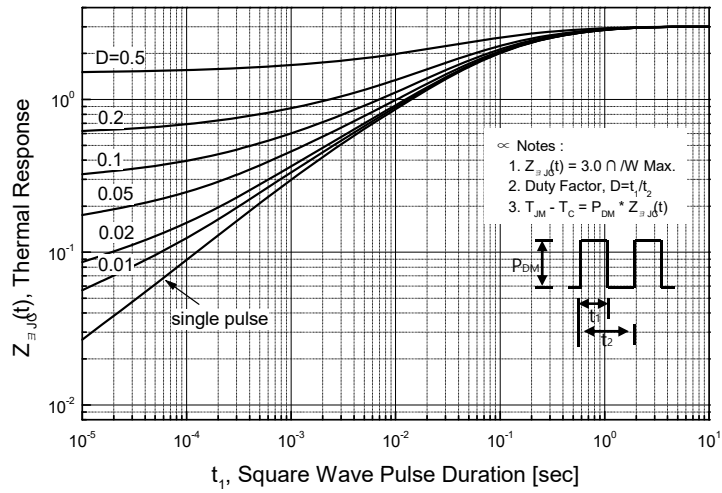
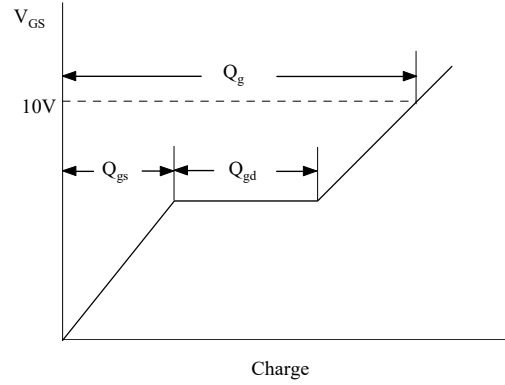
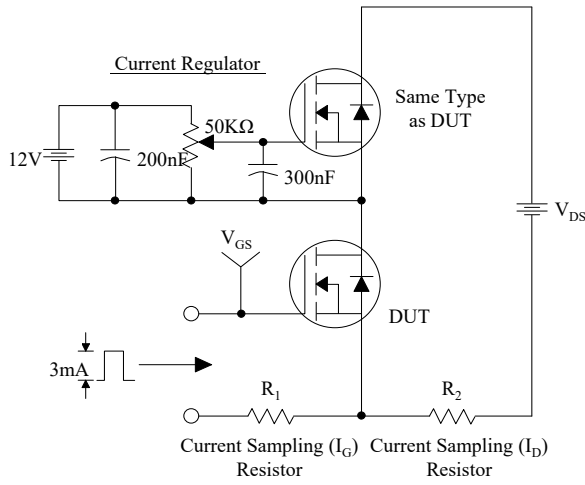
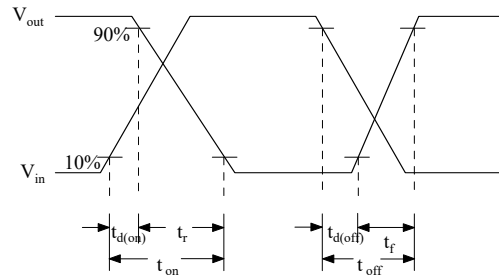
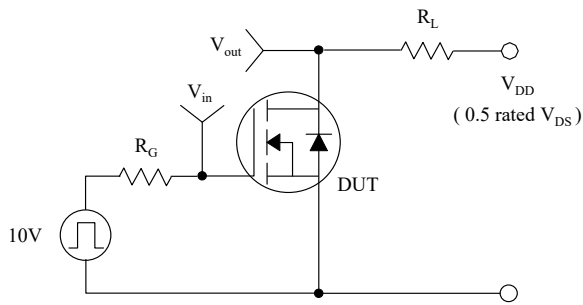


Figure 11-2. Transient Thermal Response Curve for SLF32N20C

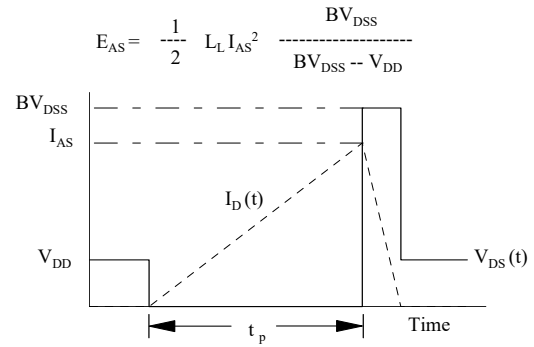
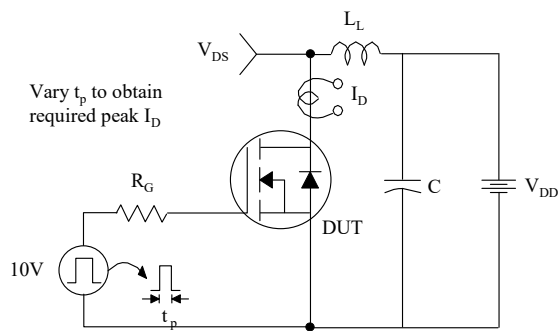
Gate Charge Test Circuit & Waveform



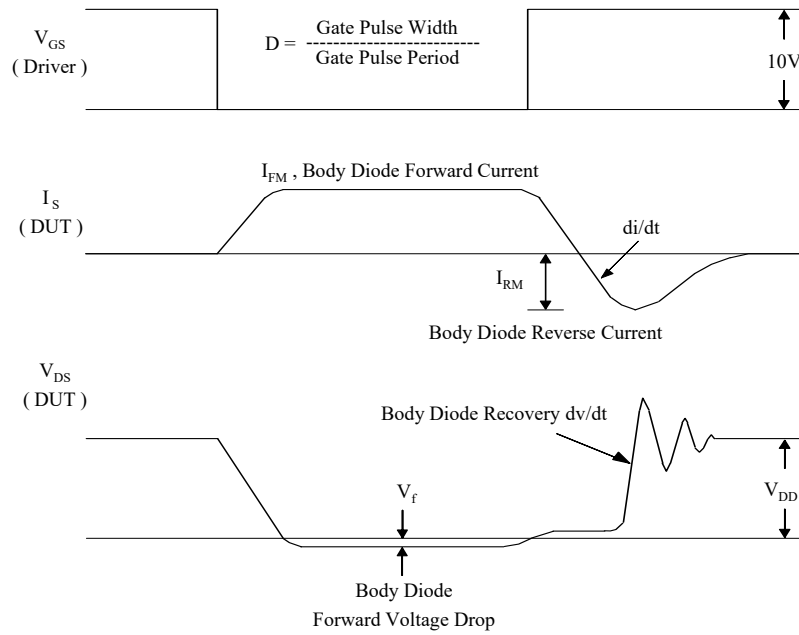
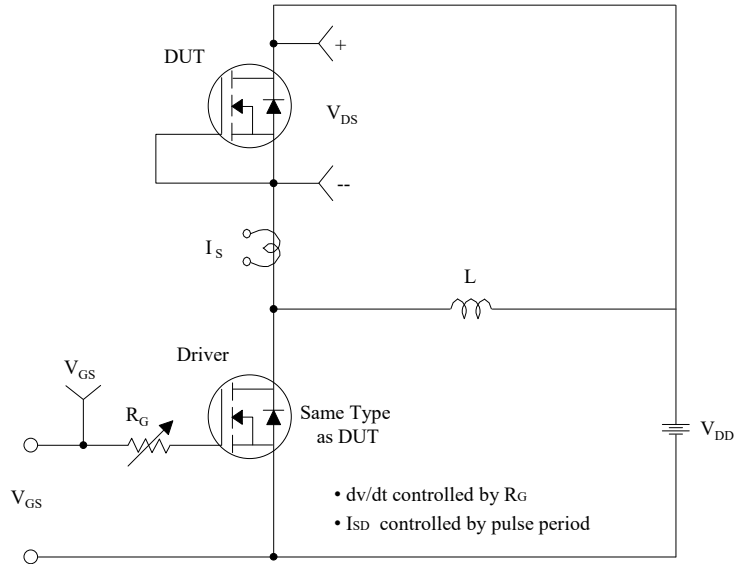
Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching Test Circuit & Waveforms



Peak Diode Recovery dv/dt Test Circuit & Waveforms



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